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Hyperfast Rectifier, 30 A FRED Pt®



PRIMARY CHARACTERISTICS								
I _{F(AV)} 30 A								
V _R	650 V							
V _F at I _F at 125 °C	1.6 V							
t _{rr}	27 ns							
T _J max.	175 °C							
Package	TO-220AC 2L							
Circuit configuration	Single							

FEATURES

- Hyper fast and soft recovery time
- Low forward voltage drop
- 175 °C maximum operating junction temperature
- Low leakage current
- True 2 pin package
- AEC-Q101 qualified
- FREE • Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION / APPLICATIONS

Ultra low V_F, soft-switching hyper fast rectifiers optimized for discontinuous (critical) mode (DCM) power factor correction (PFC).

The minimized conduction loss, optimized stored charge and low recovery current minimized the switching losses and reduce over dissipation in the switching element and snubbers.

The device is also intended for use as a freewheeling diode in power supplies and other power switching applications.

ABSOLUTE MAXIMUM RATINGS										
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS						
Repetitive peak reverse voltage	V _{RRM}		650	V						
Average rectified forward current	I _{F(AV)}	T _C = 120 °C	30	٨						
Non-repetitive peak surge current	I _{FSM}	T _C = 25 °C	210	A						
Operating junction and storage temperature	T _J , T _{Stg}		-55 to +175	°C						

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)										
PARAMETER	MIN.	TYP.	MAX.	UNITS						
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 250 μA	650	-	-	V				
Forward voltage	V _F	I _F = 30 A	-	2.1	2.5	V				
Forward voltage		I _F = 30 A, T _J = 125 °C	-	1.6	1.7					
Reverse leakage current	1	$V_{R} = V_{R}$ rated	-	0.02	30					
neverse leakage current	I _R	$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	50	300	μΑ				
Junction capacitance	CT	V _R = 200 V	-	22	-	pF				
Series inductance	L _S	Measured lead to lead 5 mm from package body	-	8.0	-	nH				





RoHS

COMPLIANT

HALOGEN



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DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25$ °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS			
Reverse recovery time	t _{rr}	T _J = 25 °C	I _F = 1 A dI _F /dt = 100 A/µs V _R = 30 V	-	35	-	ns			
	-11	T _J = 25 °C		-	27	-				
		T _J = 125 °C		-	88	-				
Dook roooyon (ourront	1	T _J = 25 °C	$I_F = 30 A$	-	15	-	А			
Peak recovery current	I _{RRM}	T _J = 125 °C	dl _F /dt = 1000 A/µs V _B = 400 V	-	24	-	A			
	Q _{rr}	T _J = 25 °C		-	330	-	20			
Reverse recovery charge		T _J = 125 °C		-	1350	-	nC			

THERMAL - MECHANICAL SPECIFICATIONS										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Thermal resistance, junction to case	R _{thJC}		-	1.0	1.3					
Thermal resistance, junction to ambient	R _{thJA}	Typical socket mount	-	-	70	°C/W				
Thermal resistance, case to heat sink	R _{thCS}	Mounting surface, flat, smooth, and greased	-	-	0.5					
Weight			-	0.2	-	g				
Weight			-	0.07	-	oz.				
Mounting torgue			6.0		12	kgf · cm				
Mounting torque			(5.0)	-	(10)	(lbf \cdot in)				
Maximum junction and storage temperature range	T _J , T _{Stg}		-55	-	175	°C				
Marking device		Case style: TO-220AC 2L		ETX3	007TH					

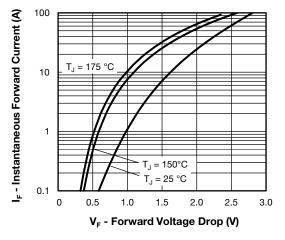


Fig. 1 - Typical Forward Voltage Drop Characteristics

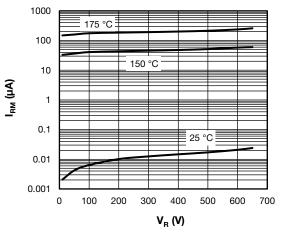


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage





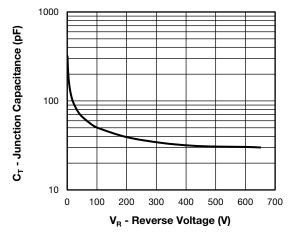


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

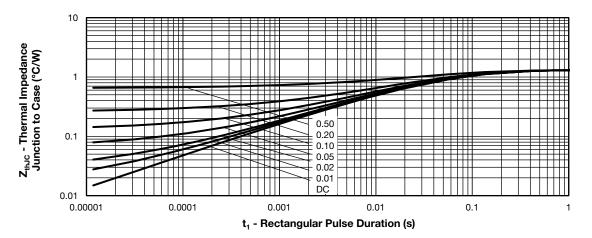
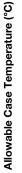
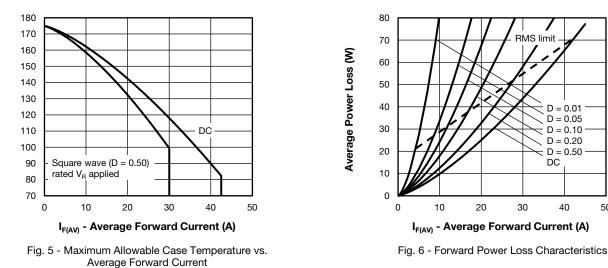


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics





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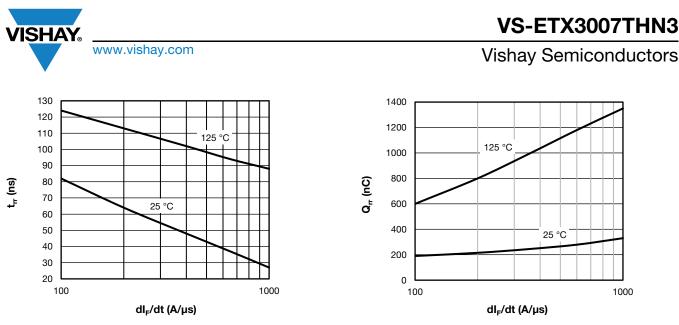


Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

Fig. 8 - Typical Reverse Recovery Time vs. dl_F/dt

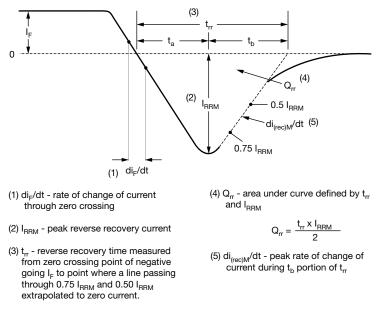


Fig. 9 - Reverse Recovery Waveform and Definitions





ORDERING INFORMATION TABLE

Device code	VS-	Е	т	x	30	07	Т	Н	N3
		2	3	4	5	6	7	8	9
	1 - 2 - 3 - 3 - 4 - 5 - 6 - 7 - 8 -	E = Pac T = X = Cur Volt T =	single c kage: TO-220 hyper fa rent rati age rati True 2 p		very : 30 A) : 650 V) 220				
	9 -			ntal digit en-free,		omplia	nt, and f	totally le	ead (Pb)

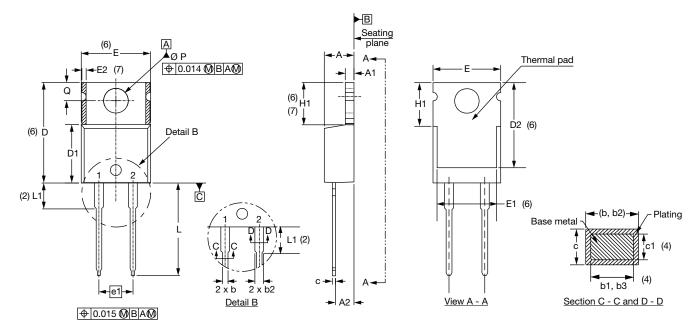
ORDERING INFORMATION (Example)									
PREFERRED P/N QUANTITY PER TUBE MINIMUM ORDER QUANTITY PACKAGING DESCR									
VS-ETX3007THN3	50	1000	Antistatic plastic tube						

LINKS TO RELATED DOCUMENTS							
Dimensions	www.vishay.com/doc?96069						
Part marking information	www.vishay.com/doc?95391						
SPICE model	www.vishay.com/doc?96532						



TO-220AC 2L

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INC	HES	NOTES	SYMBOL	MILLIN	IETERS	INC	HES	NOTES
SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES	SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.25	4.65	0.167	0.183		E1	6.86	8.89	0.270	0.350	6
A1	1.14	1.40	0.045	0.055		E2	-	0.76	-	0.030	7
A2	2.56	2.92	0.101	0.115		e1	4.88	5.28	0.192	0.208	
b	0.69	1.01	0.027	0.040		H1	5.84	6.86	0.230	0.270	6, 7
b1	0.38	0.97	0.015	0.038	4	L	13.52	14.02	0.532	0.552	
b2	1.20	1.73	0.047	0.068		L1	3.32	3.82	0.131	0.150	2
b3	1.14	1.73	0.045	0.068	4	ØΡ	3.54	3.73	0.139	0.147	
с	0.36	0.61	0.014	0.024		Q	2.60	3.00	0.102	0.118	
c1	0.36	0.56	0.014	0.022	4						
D	14.85	15.25	0.585	0.600	3						
D1	8.38	9.02	0.330	0.355							
D2	11.68	12.88	0.460	0.507	6						
E	10.11	10.51	0.398	0.414	3, 6						

Notes

⁽¹⁾ Dimensioning and tolerancing as per ASME Y14.5M-1994

⁽²⁾ Lead dimension and finish uncontrolled in L1

(3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

⁽⁴⁾ Dimension b1, b3 and c1 apply to base metal only

⁽⁵⁾ Controlling dimension: inches

⁽⁶⁾ Thermal pad contour optional within dimensions E, H1, D2 and E1

 $^{\left(7\right) }$ Dimension E2 x H1 define a zone where stamping and singulation irregularities are allowed

⁽⁸⁾ Outline conforms to JEDEC[®] TO-220, except D2, where JEDEC[®] minimum is 0.480"

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